

PS2861B-1

4-PIN SSOP PHOTOCOUPLER OPERATING AMBIENT TEMPERATURE 110°C

DESCRIPTION

The PS2861B-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor.

The package has a shield effect to cut off ambient light, and is mounted in a Shrink SOP (Small Outline Package) for high density applications.

Due to the high isolation voltage between the input and output, the PS2861B-1 is suitable for interface and signal transfer circuits that require surface or high-density mounting.

FEATURES

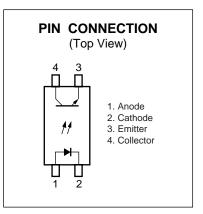
- Operating ambient temperature: 110°C
- Isolation distance (0.4 mm MIN.)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Shrink SOP (Small Outline Package) type
- High-speed switching ($t_r = 4\mu s TYP_{..}, t_f = 5\mu s TYP_{.}$)
- Embossed tape product: PS2861B-1-F3: 3 500 pcs/reel
- Pb-Free product
- Safety standards

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- UL approved: No. E72422
- CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
- BSI approved (BS EN 60065, BS EN 60950)
- SEMKO, NEMKO, DEMKO, FIMKO approved (EN 60065, EN60950)
- CQC approved (GB8898, GB4943)
- DIN EN 60747-5-5 (VDE 0884-5) approved (Option)

APPLICATIONS

- Power supply
- Programmable logic controllers



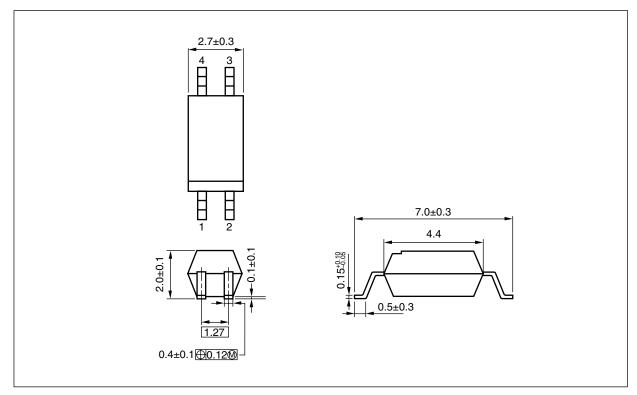
The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.



R08DS0100EJ0300 Rev.3.00 Jan 23, 2013

PACKAGE DIMENSIONS (UNIT: mm)

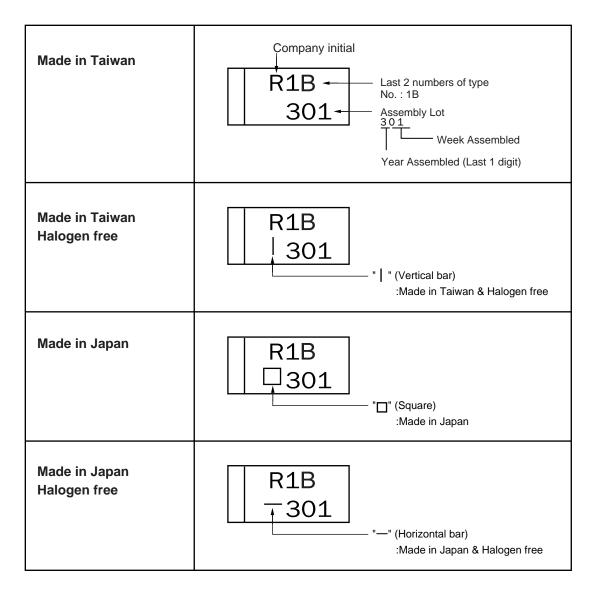


PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	5.0 mm
Creepage Distance	5.0 mm
Isolation Distance	0.4 mm



<R> MARKING EXAMPLE





<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS2861B-1-F3	PS2861B-1Y-F3-A	Pb-Free and Halogen Free	Embossed Tape 3 500 pcs/reel	Standard products (UL, CSA, BSI, SEMKO, NEMKO, DEMKO, FIMKO, CQC approved)	PS2861B-1
PS2861B-1-V-F3	PS2861B-1Y-V-F3-A		Embossed Tape 3 500 pcs/reel	DIN EN 60747-5-5 (VDE 0884-5) approved (Option)	

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current (DC)	١ _F	50	mA
	Reverse Voltage	V _R	6	V
	Power Dissipation Derating	⊿P _D /°C	0.6	mW/°C
	Power Dissipation	P _D	60	mW
	Peak Forward Current ^{*1}	I _{FP} 1	2.5	А
	Peak Forward Current ^{*2}	I _{FP} 2	1.0	
Transistor	ransistor Collector to Emitter Voltage		70	V
	Emitter to Collector Voltage	V _{ECO}	5	V
	Collector Current	Ι _C	50	mA
	Power Dissipation Derating	⊿P _c /°C	1.2	mW/°C
Power Dissipation		Pc	120	mW
Isolation Voltage ^{*3}		BV	3 750	Vr.m.s.
Operating A	mbient Temperature	T _A	-55 to +110	°C
Storage Ter	torage Temperature		–55 to +150	°C

Notes: *1. PW = 10 μ s, Duty Cycle = 1%

*2. PW = 100 μ s, Duty Cycle = 1%

*3. AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.



	Parameter		Symbol Conditions		TYP.	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 5 mA		1.1	1.4	V
	Reverse Current	I _R	V _R = 5 V			5	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		15		pF
Transistor	Collector to Emitter Dark Current	I _{CEO}	I _F = 0 mA, V _{CE} = 24 V			100	nA
Coupled	Current Transfer Ratio $(I_C/I_F)^{*1}$	CTR	I _F = 5 mA, V _{CE} = 5 V	50	150	300	%
			I _F = 1 mA, V _{CE} = 5 V	10	50		
	Collector Saturation Voltage	V _{CE (sat)}	I _F = 10 mA, I _C = 2 mA			0.3	V
	Isolation Resistance	R _{I-O}	V _{I-O} = 1 kV _{DC}	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.4		pF
	Rise Time ^{*2}	tr	V_{CC} = 5 V, I_C = 2 mA, R_L = 100 Ω		4		μs
	Fall Time ^{*2}	t _f			5		
	Turn-on Time ^{*2}	t _{on}			5		
	Turn-off Time ^{*2}	t _{off}			5		

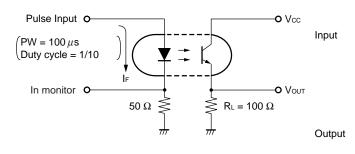
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

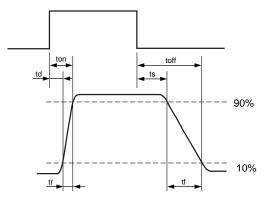
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Notes: *1. CTR rank

CTR rank	CTR (%)	Conditions
L	100 to 300	I_F = 5 mA, V_{CE} = 5 V
	20 and larger	I_{F} = 1 mA, V_{CE} = 5 V
М	50 to 150	$I_{\rm F}$ = 5 mA, $V_{\rm CE}$ = 5 V
	10 and larger	I_{F} = 1 mA, V_{CE} = 5 V
N	50 to 300	$I_{\rm F}$ = 5 mA, $V_{\rm CE}$ = 5 V
	10 and larger	I_{F} = 1 mA, V_{CE} = 5 V

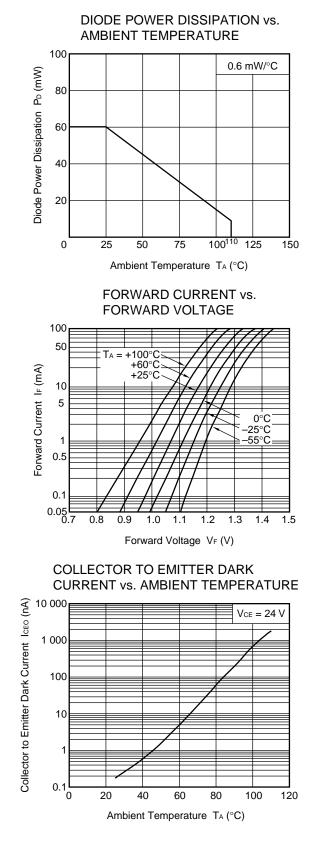
*2. Test Circuit for Switching Time





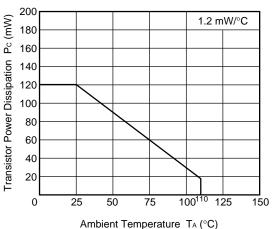


TYPICAL CHARACTERISTICS ($T_A = 25^{\circ}C$, unless otherwise specified)

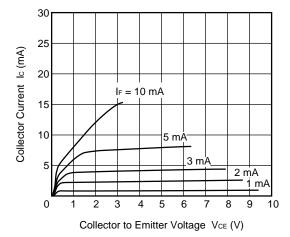




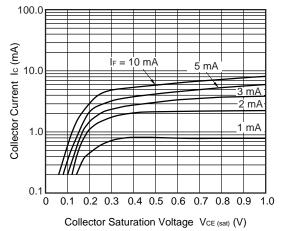
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE

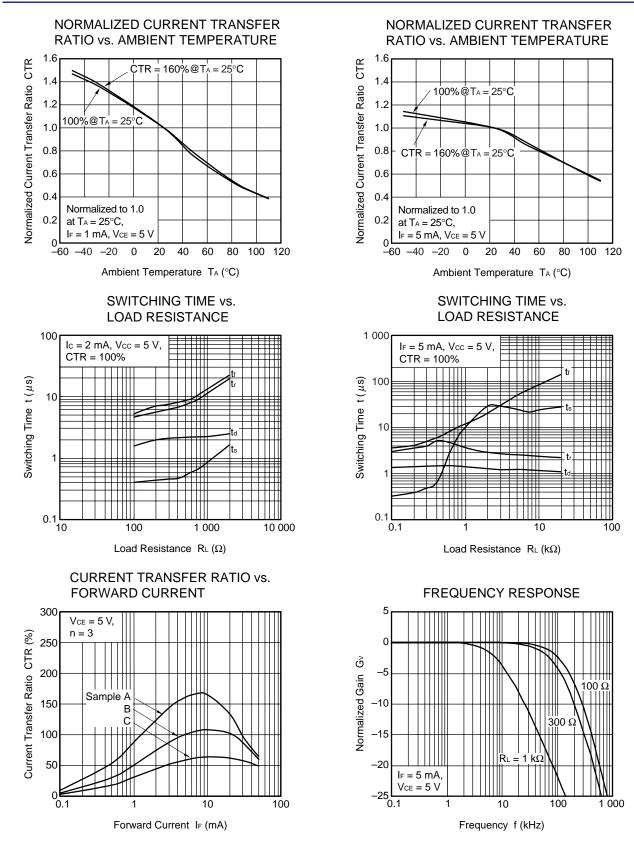


COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE

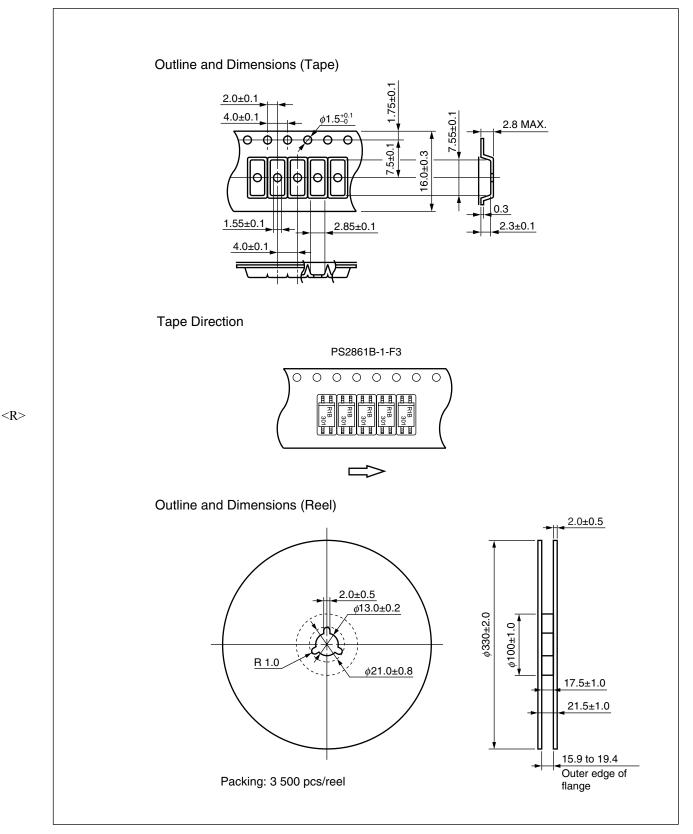




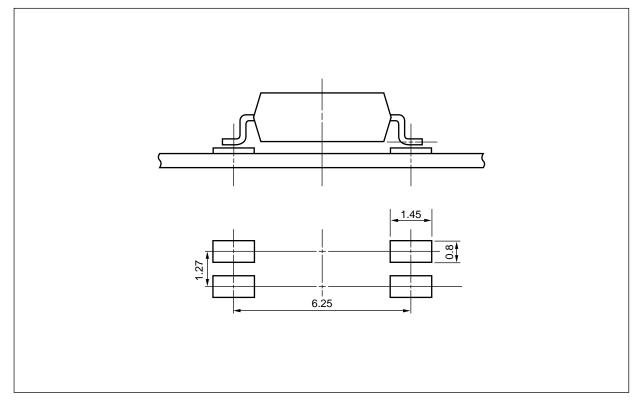




TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.



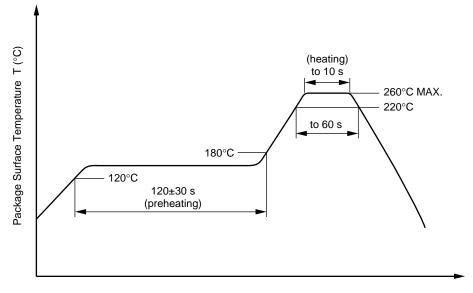
NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature
 - Time of peak reflow temperature
 - Time of temperature higher than 220°C
 - Time to preheat temperature from 120 to 180°C
 - Number of reflows
 - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is

Recommended Temperature Profile of Infrared Reflow

recommended.)





(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350°C or below
- Time (each pin) 3 seconds or less
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

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• Fluxes Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.



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2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collectoremitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



SPECIFICATION O	F VDE	MARKS	LICENSE	DOCUMENT
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	Parameter	Symbol	Spec.	Unit
	Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/110/21	
<r></r>	Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test)	U _{IORM} U _{pr}	710 1 136	V _{peak} V _{peak}
<r></r>	U_{pr} = 1.6 × U_{IORM} , P_d < 5 pC			
	Test voltage (partial discharge test, procedure b for all devices) U_{pr} = 1.875 \times U _{IORM} , P _d < 5 pC	Upr	1 331	V _{peak}
	Highest permissible overvoltage	U _{TR}	6 000	V _{peak}
	Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
	Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
	Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
	Storage temperature range	T _{stg}	-55 to +150	°C
	Operating temperature range	T _A	-55 to +110	°C
	Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc}$ at $T_A = 25^{\circ}\text{C}$ $V_{IO} = 500 \text{ V dc}$ at T_A MAX. at least 100°C	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
	Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve)			
	Package temperature	Tsi	175	°C
	Current (input current I _F , Psi = 0)	lsi	400	mA
	Power (output or total power dissipation) Isolation resistance	Psi	700	mW
	V _{IO} = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω



Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	 Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.



Revision History

PS2861B-1 Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Jan 28, 2009	-	This data sheet was released as PN10742EJ01V0DS	
3.00	Jan 23, 2013	Throughout	Renesas format is applied to this data sheet.	
		p.1	The safety standards are revised.	
		p.3	The explanation in MARKING EXAMPLE is revised.	
		p.4	ORDERING INFORMATION is modified with the revision of the safety	
			standards.	
		p.5	Turn-on Time (t_{on}) and Turn-off Time(t_{off}) are added to the table in	
			ELECTRICAL CHARACTERISTICS.	
		p.8	The image in Tape Direction is revise.	
		p.10	The note about temperature condition of the recommended soldering	
			conditions is deleted.	
		p.12	The value of Upr is changed from the value, 1 065 and the factor, 1.5 of U_{IORM}	
			is changed from 1 136 and 1.6, respectively.	

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